IN-F20IR-MH (730nm)

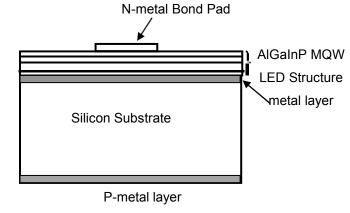
1. Descriptions:

IN-F20IR-MH is a deep reddish LED chip made from Aluminum Gallium Indium Phosphide (AlGaInP) MOCVD process and bonded with Silicon. It is fabricated by the HPO's proprietary metal Bonding mechanism, IN-F20IR-MH is featured by homogeneous and high light output at all sides with superior beam pattern. Excellent performance and reliable life-long stability make IN-F20IR-MH ideal for horticultural and medical applications.

2. Chip Diagram:



Chip pattern





3. Chip characteristics:

Substrate	Si		
Emitting material	AlGaInP		
p-pad electrode	Au-alloy		
n-pad electrode	Au-alloy		
Chip size	500±25um × 500±25um		
Chip thickness	150±25um		
Pad Diameter	100±15um		

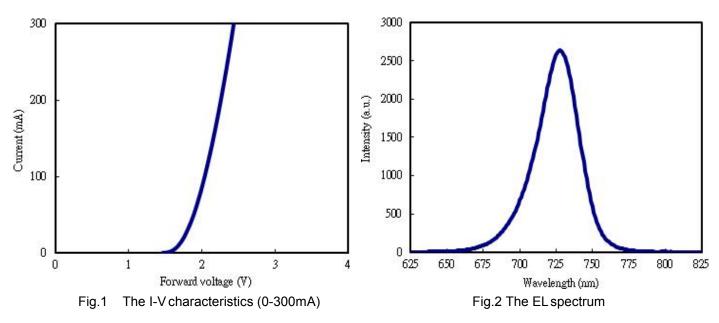
4. Electrical and Optical Characteristics(Ta=25^oC):

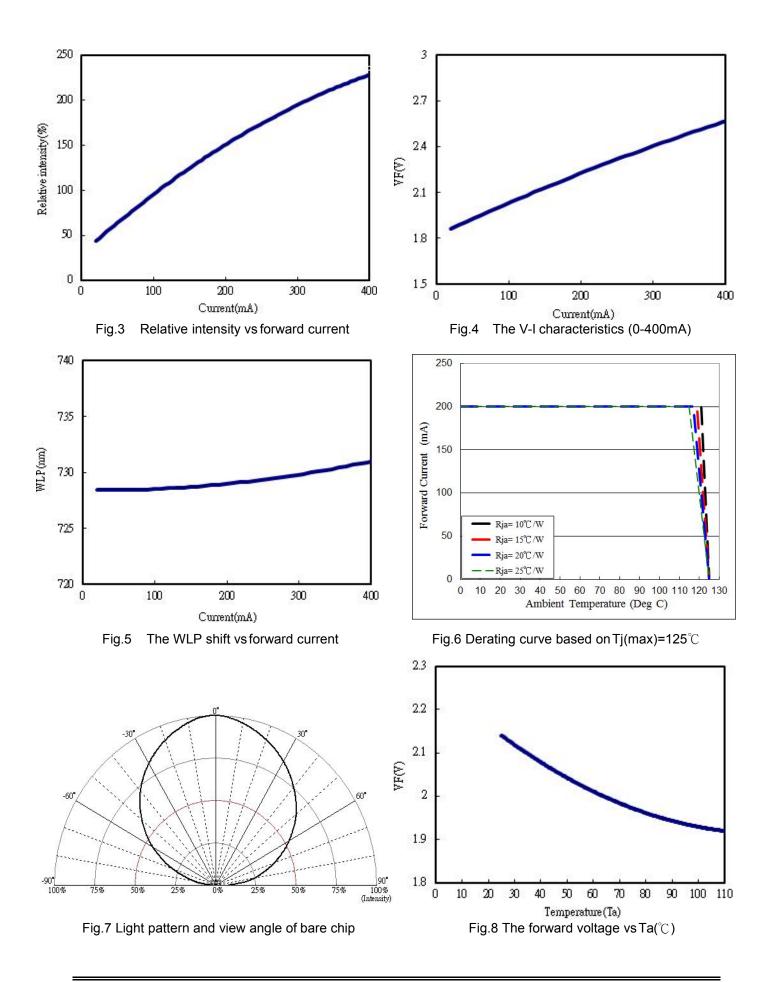
Parameter	Condition *1	Symbol	Min.	Тур.	Max.	Unit
Forward voltage	I⊧=150mA	V _{F1}	1.7	-	2.3	V
Threshold voltage	I⊧=10uA	V _{F3}	1.3	-	1.8	V
Reverse current	V _R =5V	IR	-	-	10.0	uA
Peak wavelength	I⊧=150mA	λρ	725	-	735	nm
Half width *2	I⊧=150mA	Δλ	-	32	-	nm
Radiant power *3	l⊧=150mA	Po	70	-	-	mW

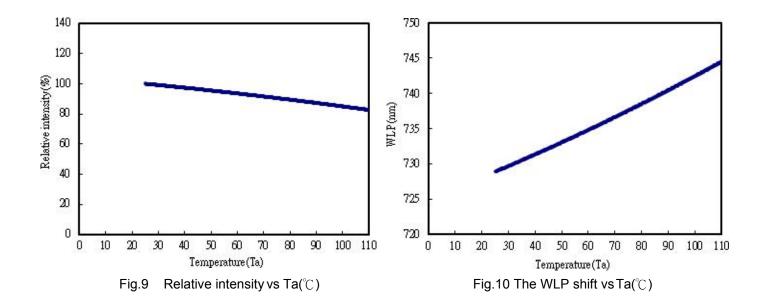
Note:

- *1 IF : DC Forward current VR : Reverse voltage
- *2 Value of Half width is only for reference
- *3 Luminous Intensity is measured by HPO's equipment on bare chips.
- *4 Characteristic curves are measured on standard TO-39 package type without encapsure.

5. Characteristic Curves:







6. Absolute Maximum Ratings(Ta=25^oC):

Parameter	Symbol	Condition	Rating	
DC Forward Current	lf	Ta=25 ℃	\leq 200mA	
Peak Pulsing Current	Ipeak	1/10 duty cycle @ 1kHz	\leq 350mA	
Reverse Voltage	VR	Ta=25℃	\leq 10V	
Operating Temperature Range	Тор	-	-40°C to +85°C	
Storage Temperature Range	Tstg	Chip-on-tape/storage	+5℃ to +30℃	
		Chip-on-tape/transportation	-20℃ to +65℃	
LED Junction Temperature	Tj	-	≦ 125 ℃	
Temperature during Packaging	-	-	280°C (<10sec)	

Note: Maximum ratings are package dependent. The above maximum ratings were determined using a Metal Core Printed Circuit Board(MCPCB) without an encapsulant. Stress in excess of the absolute maximum ratings such as forward current and junction temperature may cause damage to the LED.